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## Paper

## **Electronic supplementary information**

## Layer-structured 3D Nanohybrid MoS<sub>2</sub>@rGO on Nickel Foam for High Performance Energy Storage Applications

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# **Supplementary information**

### 1) LBL method

A layer by layer (LBL) technique was employed to coat the electrode electrostatically with GO (Fig. **S1**). The GO dispersion was prepared by adding 100 mg in 20 ml deionized water. The GO solution was stirred at 700 rpm for one hour until it become a colloidal suspension. Briefly, the cleaned nickel foam (NF) was dipped in a colloidal GO suspension for 10 min, washed with D.I. water, and dried in an oven. One cycle of this procedure gave a film composed of a monolayer graphene oxide, and repetitive (5–10) cycles, a multilayer GO film. The deposited films were reduced using a reducing agent. Chemical reduction was conducted by dipping multi-layered GO films in an aqueous solution of 0.1 M  $N_2H_4$  (hydrazine) for 24 h at 70° C, followed by washing with D.I. water.



Fig. S1: Schematic of the coating process of GO by LBL method.

### 2) SILAR method

In 1985, Nicolau introduced the SILAR method (Fig. **S2**) to grow polycrystalline or epitaxial thin films of water-insoluble ionic or covalent compounds of the  $C_mA_n$  type by heterogeneous chemical reactions at the solid-solution interface between the adsorbed cations ( $CL_p$ )<sup>n+</sup> and anions ( $AL'_q$ )<sup>m-</sup>according to eq. 1.<sup>1</sup>

 $m(CL_p)^{n+} + n(AL'_q)^{m-} \rightarrow C_m A_n \downarrow + mpL + nqL'$  .....(1)

where  $L_p$  and  $L'_q$  are ligands. This method involves the alternative immersion of the current collector in a solution containing a soluble salt of the cation and anion of the compounds to be grown. This aqueous solution phase has been reported for the deposition of  $MoS_2$  on stainless steel substrates to produce large volumes of monolayers and a few layers that can be deposited onto a substrate to form films.



Fig.S2: Schematic diagram of the coating process of MoS2@rGO by SILAR method [2].

Analytical reagent ammonium molybdate  $[(NH_4)_6Mo_7O_{24}\cdot 4H_2O]$  and sodium sulfide  $[Na_2S\cdot H_2O]$  were used in the deposition of the MoS<sub>2</sub> 3D electrode. The cation precursor was 0.01 M ammonium molybdate solution. The pH was adjusted to 3 by adding dilute sulfuric acid. The source of sulfur ions was 1 M sodium sulfide (pH ~ 13.5). Prepared solutions were taken into beakers and D.I. water was used for rinsing. After every ten deposition cycles, the D.I. water for rinsing was replaced. Deposition was carried out at room temperature (27° C) using unstirred reaction solutions. By making several trials of the time durations for adsorption, reaction and rinsing were optimized. The chemically reduced rGO-decorated 3D porous nickel foam (rGO@NF) was immersed in 0.01 M ammonium molybdate for 25 s, and adsorbed ammonium molybdate (molybdenum complex).

The rGO@NF substrate was rinsed with D.I. water for 30 s to remove the desorbed ions. The substrates were immersed in a 0.1 M sodium sulfide solution for 25 s, where the S<sup>2-</sup> ions were adsorbed and reacted with Mo<sup>4+</sup> ions on the rGO@NF substrate to decorate with MoS<sub>2</sub> on 3D porous rGO@NF. The unreacted S<sup>2-</sup> ions were removed by rinsing the substrates in D.I. water for 30 s. By repeating the SILAR deposition cycles 30-50 times, homogeneous, strongly adherent, and compactly stacked MoS<sub>2</sub> layers on NF were obtained.

#### 3) SAED pattern

**Fig. S3** shows the selected area energy dispersion (SAED) pattern of MoS<sub>2</sub>@rGO electrode, it confirms the polycrystalline nature of the MoS<sub>2</sub>@rGO materials.



Fig. S3: Selected area energy dispersion (SAED) pattern of MoS<sub>2</sub>@rGO electrode.

#### 4) Elemental mapping

In Figs. **S4 (a-d)**, C, Mo, and S were distributed over the same area, verifying the formation of  $MoS_2$  on the rGO surface. The peaks for C, Mo, and S in Fig. **S4 (e)** also confirm the formation of the composite. The peaks around 8 and 9 were formed due to the copper grid that held the sample.



Fig.S4 TEM image of MoS<sub>2</sub>@rGO (individual rGO sheet decorated by MoS<sub>2</sub>)
(a); EDS of C (b), Mo (c), S (d) elemental maps and EDS spectra (e) taken from the same area.

#### 5) Equations for supercapacitor calculations

The specific capacitance  $C_{sp}$  was calculated by eq. **S1**:

$$C_{sp} = \frac{\int_{V_1}^{V_2} i \, dV}{(V_2 - V_1)vm}$$
(S1)

where *i* represents current response to the given voltage (V),  $V_1$  and  $V_2$  are the lower and upper potential limits, respectively,  $\nu$  is the scan rate, and *m* is the mass of the electrode.

Specific capacitance from the charge-discharge plot was calculated by eq. S2:

$$C_{sp} = \frac{it}{m\Delta v}$$
(S2)

where *t* is the discharge time and  $\Delta v$  is the potential window. Here, *i/m* can be replaced by the current density. The energy density (*E*) and power density (*P*) were calculated using eqs. **S3** and **S4**:

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$$E = \frac{1}{2}C_{sp}(\Delta \nu)^2$$
(S3)

$$P = \frac{E}{t}$$
(S4)

### 6) EIS study for electrodes after cyclic stability tests



**Fig. S5:** Nyquist plots of (a)  $MoS_2$  and (b)  $MoS_2@rGO$  electrodes after 2000 cycles within the frequency range, 40 kHz to 0.1 Hz.

### 7) SEM images after cycling



Fig. S6: SEM images of (a) MoS<sub>2</sub> and (b) MoS<sub>2</sub>@rGO electrodes after 2000 cycles.

### 8) Comparison of the reported supercapacitors

**Table S1:** Supercapacitor properties of the materials reported in the literature andobtained from this study

Material	Specific capacitance, [F g <sup>-1</sup> ]	Energy density [Wh kg <sup>-1</sup> ]	Power density [kW kg <sup>-1</sup> ]	Stability [%] (Cycles)	Ref.				
MoS <sub>2</sub> composite with graphene or modified graphene									
2D MoS₂@rGO	265	63		92 (1000)	[3]				
MoS <sub>2</sub> @chemically modified graphene	257	-	-	93 (1000)	[4]				
MoS₂@GNS	282	-	-	93 (1000)	[5]				
MoS <sub>2</sub> @G	270	12.5	2.5	89.6 (1000)	[6]				
MoS <sub>2</sub> @N-G	245	-	-	91.3 (1000)	[7]				
MoS <sub>2</sub> @G*	46* (50ª)	<b>7</b> *c	3.5 <sup>*e</sup>	240* (3500)	[8]				
MoS <sub>2</sub> @S-rGO*	6.56*ª	0.58* <sup>d</sup>	13.4* <sup>f</sup>	91* (1000)	[9]				
$MoS_2@rGO*$	30* <sup>b</sup>	-	-	-	[10]				
MoS₂@rGO	1064 (4,700ª)	47.6 (66.8°)	7.63 (3.7 <sup>d</sup> )	95 (2000)	This work				

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MoS <sub>2</sub> composite with carbon										
MoS <sub>2</sub> @C	210	-	-	105 (1000)	[11]					
MoS₂@C	589	72.7	12	104 (2000)	[12]					
MoS <sub>2</sub> @N-C	158	-	-	89 (1000)	[13]					
MoS₂@C	201	-	-	94.1 (1000)	[14]					
MoS₂@MPC	189	-	-	98 3000	[15]					
MoS <sub>2</sub> /graphene* membranes	4.29* <sup>a</sup>	-	-	~250* (10 000)	[16]					
MoS <sub>2</sub> composite with polymer										
PPY@MoS <sub>2</sub>	554	49.2	5.8	90 (500)	[17]					
PANI@ MoS <sub>2</sub>	552	-	-	79 (6000)	[18]					
PANI@ MoS <sub>2</sub>	853	-	-	91 (4000)	[19]					
PANI@ MoS <sub>2</sub>	567	-	-	92 (500)	[20]					
PPy@ MoS <sub>2</sub>	700	83.3	3.33	85 4000	[21]					
MoS₂@PANI	390	-	-	86 (1000)	[22]					
PANI@MoS₂@C	678	-	-	80 (10,000)	[23]					
MoS <sub>2</sub> composite with metal oxide/sulfide										
CeO <sub>2</sub> @MoS <sub>2</sub>	102ª	84 <sup>b</sup>	3.5 <sup>e</sup>	94 (2000)	[24]					
Ni <sub>3</sub> S <sub>4</sub> @MoS <sub>2</sub>	1441	-	-	90.7 (3000)	[25]					
$Ni_3S_2@MoS_2$	1165	-	-	91 (2000)	[26]					
MoS <sub>2</sub> @Ni(OH) <sub>2</sub> *	516*	5.2* <sup>c</sup>	11* <sup>f</sup>	94.2 (9000)	[27]					

\* Values from supercapacitor device,

a:  $[mF \ cm^{-2}]$ , b:  $[F/cm^{3]}$ ; c:  $[\mu Wh \ cm^{-2}]$ , d:  $[mWh \ cm^{-3}]$ , e:  $[mW \ cm^{-2}]$ , and f:  $[W \ cm^{-3}]$ 

#### 9) Supercapacitive properties of asymmetric supercapacitors (ASCs) MoS<sub>2</sub>// rGO:

Electrochemical studies of the  $MoS_2//rGO$  ASC device: cyclic voltammograms at various potential ranges from 0.8 to 1.8 V in PVA-KOH gel electrolyte at a scan rate of 100 mV s–1, voltammetric response of  $MoS_2//rGO$  ASC device at different scan rates, galvanostatic charge-discharge curves of



 $MoS_2//rGO$  within the potential range 1.6 V at different current densities, and Ragone plot for  $MoS_2//rGO$  ASC device at different current densities. Inset fig d shows capacitance retention of ASC.

**Fig. S7**: Electrochemical studies of the  $MoS_2//rGO$  ASC device: (a) cyclic voltammograms within the various potential ranges from 0.8 to 1.8 V in PVA-KOH gel electrolyte at a scan rate of 100 mV s–1, (b) voltammetric response of MoS2//rGO ASC device at different scan rates, (c) galvanostatic chargedischarge curves of  $MoS_2//rGO$  within the potential range 1.6 V at different current densities, and (d) Ragone plot for  $MoS_2//rGO$  ASC device at different current densities. The inset of (d) shows the variation of the specific capacitance with different current densities.

#### 10) EIS and Stability studies of MoS<sub>2</sub>// rGO:

The Nyquist plot of  $MoS_2//rGO$  ASC device and stability studies for 2000 cycles at the current density 4.5 A g<sup>-1</sup>.



**Fig. S8**: Nyquist plot of  $MoS_2//rGO$  ASC device over the frequency range, 10 MHz to 0.01 Hz (a) and cyclic stability of  $MoS_2//rGO$  ASC device for 4000th cycles (b).

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